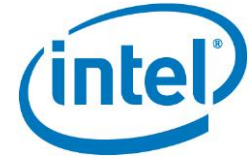


Intel Corporation

JF3, 2111 N.E. 25th Avenue
Hillsboro, OR 97124-5961
May 6th, 2019



Ms. Susanna Kooistra
Mr. Issam Toufik
Mobile Competence Center (ETSI)
650, Route Des Lucioles
Sophia-Antipolis, France

Subject: Nomination of Mr. Sasha Sirotkin as candidate for the 3GPP TSG RAN WG3
Vice Chairman

Dear Ms. Kooistra and Mr. Toufik,

Intel is pleased to nominate Mr. Sasha Sirotkin as a candidate for the vice chairmanship position of 3GPP TSG RAN WG3 in the elections to be held in May 2019 at RAN3#104. Sasha is representing Intel Corporation, a member of ATIS.

Sasha has over 15 years' experience in telecommunications, in product development, standardization and research. Since 2010, Sasha is the head of Intel delegation in RAN WG3. The majority of his participation has been within RAN WG3, with substantial participation in RAN WG2 and TSG RAN. Sasha served as a rapporteur for multiple work and study items in Rel-12, Rel-13 and Rel-14. As a LTE-WLAN Aggregation (LWA) work item rapporteur, Sasha demonstrated his leadership and consensus building skills in RAN WG2 and WG3 by leading this major Rel-13 work item to successful completion in timely manner. Sasha also attends IEEE, WFA and WBA meetings. A brief CV showing Sasha's experience is attached.

If elected, Sasha will strive to ensure that work in RAN WG3 is conducted in a fair, efficient and productive manner.

Intel is fully committed to provide the necessary support and resources to ensure that Sasha can successfully carry out his responsibilities. Sasha has availed himself of 3GPP supplied antitrust and competition law training in order to comply with all applicable antitrust/competition laws and regulations while acting in his capacity as the WG Vice Chairman.

Sincerely,
Geng Wu

A handwritten signature in black ink, appearing to read "Geng Wu", written in a cursive style.

Intel Fellow
General Manager, Wireless Standards Division
Intel Corporation

Sasha Sirotkin

Wireless Systems Architect, Intel Corporation

Summary Over 15 years' experience in telecommunications industry. Expertise in both LTE and WLAN layer 2, layer 3 and overall system architecture. Proven track record of leadership and consensus building in various capacities in 3GPP and other SDO and industry fora. Served as 3GPP RAN3 WG Vice Chairman since 2017.

Experience **Intel** (2010 to present). Head of Intel RAN3 delegation since 2010, also attending RAN plenary and RAN2. Served as rapporteur for: Release-12 Study on WLAN/3GPP Radio Interworking, Release-12 Work Item on WLAN/3GPP Radio Interworking, Release-13 Work Item on LTE-WLAN Radio Level Integration and Interworking Enhancement and Release-14 Work Item on Enhanced LTE-WLAN Aggregation (LWA).

Comsys (2008 to 2010, acquired by Intel). Represented Comsys in 3GPP. Was responsible for LTE protocol stack prototyping, delivered fully working prototype demonstrated at MWC 2009.

Metalink (2006 to 2008). Represented Metalink in WFA, working on Wi-Fi Protected Setup. Was responsible for 802.11 modem protocol stack and gateway product definition and architecture.

Allosity (2005 to 2006). CEO and Founder. Raised seed funding and developed a novel product in the area of CPU and Network Virtualization.

Texas Instruments (2002 to 2005). Developed IEEE 802.11 access point and home gateway products.

Education B.Sc. in Computer Science and Physics, Tel-Aviv University, Israel
M.Sc. in Machine Learning/Applied Statistics and Astrophysics, Tel-Aviv University, Israel